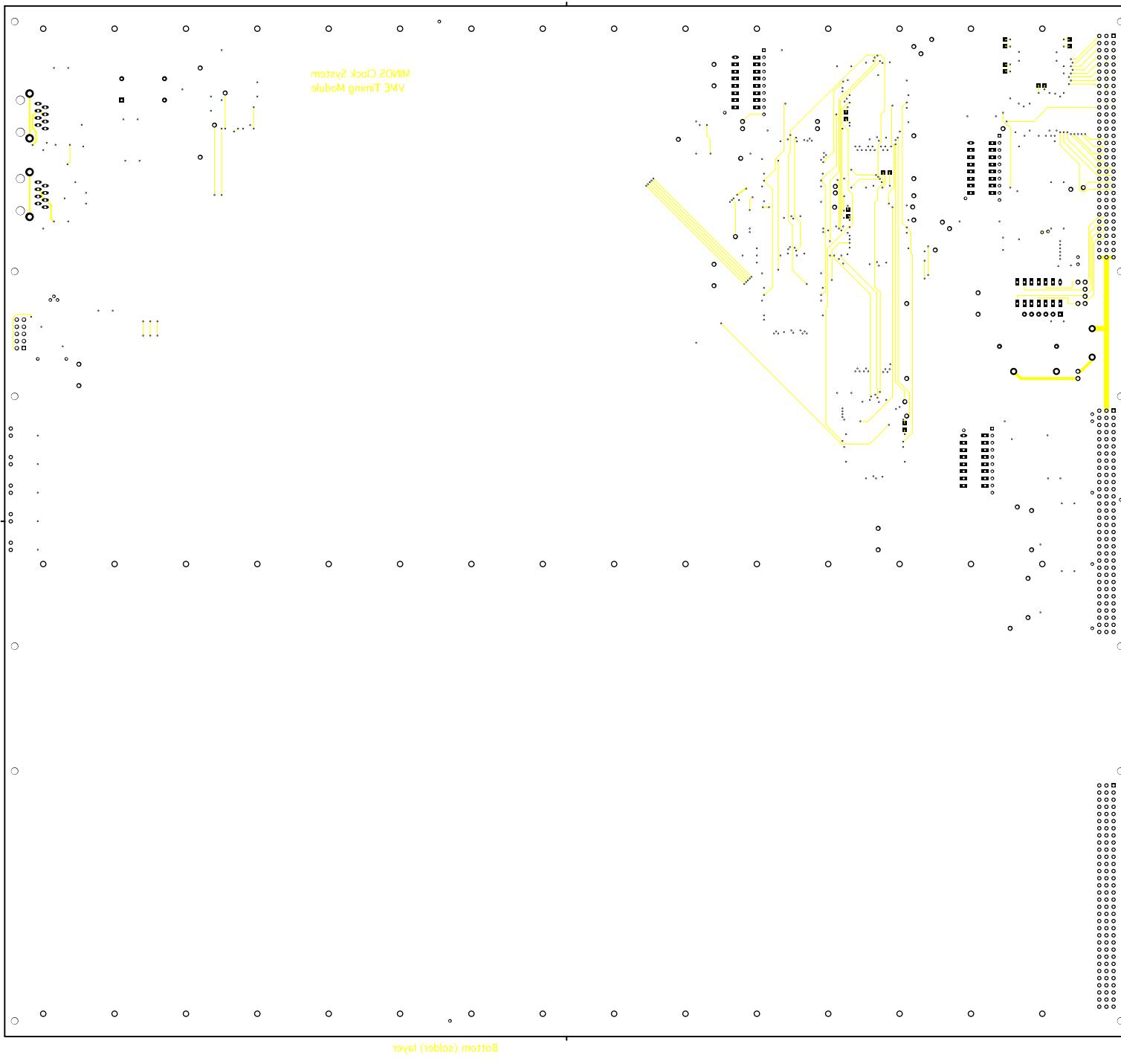


GROUND PLANE INNER LAYER



POWER PLANE (INNER LAYER)



Bottom (solder) layer

MINOS Choke Sockets
MVE Timing Modules